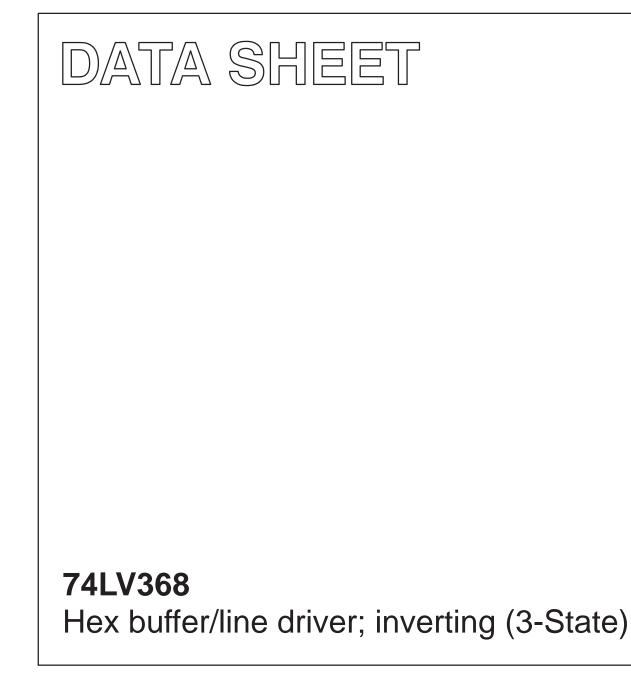
## INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Apr 07 IC24 Data Handbook

1998 May 29



Philips Semiconductors

74LV368

#### **FEATURES**

- Optimized for Low Voltage applications: 1.0 to 3.6V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7V and V<sub>CC</sub> = 3.6V
- Typical V<sub>OLP</sub> (output ground bounce) < 0.8V @ V<sub>CC</sub> = 3.3V,  $T_{amb} = 25^{\circ}C$
- Typical V<sub>OHV</sub> (output V<sub>OH</sub> undershoot)  $> 2V @ V_{CC} = 3.3V$ ,  $T_{amb} = 25^{\circ}C$
- Inverting outputs
- Output capability: bus driver
- I<sub>CC</sub> category: SSI

#### QUICK REFERENCE DATA

#### GND = 0V; $T_{amb} = 25^{\circ}C$ ; $t_r = t_f \le 2.5 \text{ ns}$

#### DESCRIPTION

The 74LV368 a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT368.

The 74LV368 is a hex inverting buffer/line driver with 3-state outputs. The 3-state outputs (nY) are controlled by the output enable inputs 10E and 20E. A HIGH on nOE causes the outputs to assume a high impedance OFF-state.

SYMBOL	PARAMETER	PARAMETER CONDITIONS			
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nA to nY	$C_L = 15 pF$ $V_{CC} = 3.3V$	9.0	ns	
Cl	Input capacitance		3.5	pF	
C <sub>PD</sub>	Power dissipation capacitance per buffer	Notes 1, 2	30	pF	

NOTES:

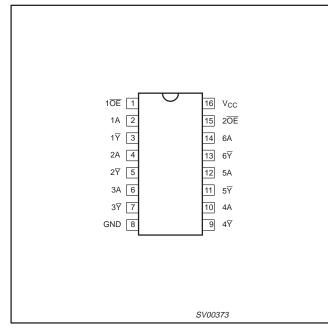
 $C_{PD}$  is used to determine the dynamic power dissipation (P\_D in  $\mu W)$ 1  $\begin{array}{l} P_{D} = C_{PD} \times V_{CC}^2 \times f_i + \Sigma \left( C_L \times V_{CC}^2 \times f_0 \right) \text{ where:} \\ f_i = \text{input frequency in MHz; } C_L = \text{output load capacitance in pF;} \\ f_o = \text{output frequency in MHz; } V_{CC} = \text{supply voltage in V;} \\ \Sigma \left( C_L \times V_{CC}^2 \times f_0 \right) = \text{sum of the outputs.} \end{array}$ 2 The condition is  $V_I = \text{GND to } V_{CC}$ 

#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	–40°C to +125°C	74LV368 N	74LV368 N	SOT38-4
16-Pin Plastic SO	–40°C to +125°C	74LV368 D	74LV368 D	SOT109-1
16-Pin Plastic SSOP Type II	–40°C to +125°C	74LV368 DB	74LV368 DB	SOT338-1
16-Pin Plastic TSSOP Type I	–40°C to +125°C	74LV368 PW	74LV368PW DH	SOT403-1

74LV368

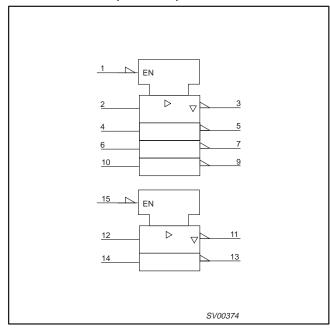




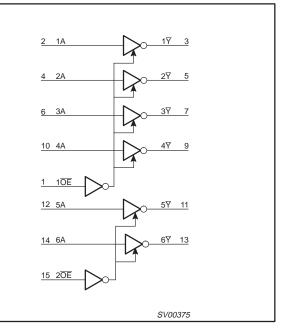
#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	FUNCTION
1, 15	10E to 20E	Output enable inputs (active LOW)
2, 4, 6, 10, 12, 14	1A to 6A	Data inputs
3, 5, 7, 9, 11, 13	1Ÿ to 6Ÿ	Bus outputs
8	GND	Ground (0V)
16	V <sub>CC</sub>	Positive supply voltage

### LOGIC SYMBOL (IEEE/IEC)

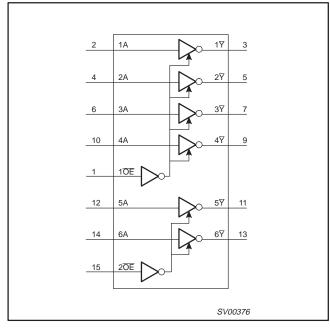


### LOGIC SYMBOL



74LV368

#### **FUNCTIONAL DIAGRAM**



#### **FUNCTION TABLE**

INP	INPUTS					
nOE	nA	nΫ				
L	L	Н				
L	Н	L				
н	Х	Z				

NOTES:

H = HIGH voltage level

L = LOW voltage level

X = Don't care

Z = High impedance OFF-state

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	See Note <sup>1</sup>	1.0	3.3	3.6	V
VI	Input voltage		0	-	V <sub>CC</sub>	V
Vo	Output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V \\ V_{CC} = 2.0V \text{ to } 2.7V \\ V_{CC} = 2.7V \text{ to } 3.6V$			500 200 100	ns/V

NOTES:

1 The LV is guaranteed to function down to  $V_{CC}$  = 1.0V (input levels GND or  $V_{CC}$ ); DC characteristics are guaranteed from  $V_{CC}$  = 1.2V to  $V_{CC}$  = 3.6V.

#### ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

In accordance with the Absolute Maximum Rating System (IEC 134); Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
±I <sub>IK</sub>	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5 V$	20	mA
±Іок	DC output diode current	$V_{O} < -0.5$ or $V_{O} > V_{CC} + 0.5V$	50	mA
±l <sub>O</sub>	DC output source or sink current – bus driver outputs	$-0.5V < V_{O} < V_{CC} + 0.5V$	35	mA
±I <sub>GND</sub> , ±I <sub>CC</sub>	DC V <sub>CC</sub> or GND current for types with –bus driver outputs		70	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package –plastic DIL –plastic mini-pack (SO) –plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

1 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2 The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-4	0°C to +8	5°C	-40°C to	o +125°C	
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	1
		V <sub>CC</sub> = 1.2V	0.9			0.9		
$V_{IH}$	HIGH level Input voltage	$V_{CC} = 2.0V$	1.4			1.4		V
	lonage	V <sub>CC</sub> = 2.7 to 3.6V	2.0			2.0		1
		$V_{CC} = 1.2V$			0.3		0.3	
VIL	LOW level Input voltage	$V_{CC} = 2.0V$			0.6		0.6	V
	l	V <sub>CC</sub> = 2.7 to 3.6V			0.8		0.8	1
		$V_{CC}$ = 1.2V; $V_I$ = $V_{IH}$ or $V_{IL;}$ – $I_O$ = 100 $\mu$ A		1.2				
\/	HIGH level output	$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	1.8	2.0		1.8		V
V <sub>OH</sub>	voltage; all outputs	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.5	2.7		2.5		<b>1</b> `
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.8	3.0		2.8		1
V <sub>OH</sub>	HIGH level output voltage; BUS driver outputs	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 8mA$	2.40	2.82		2.20		V
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0				
V	LOW level output	$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	
V <sub>OL</sub>	voltage; all outputs	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	1 `
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2	1
V <sub>OL</sub>	LOW level output voltage; BUS driver outputs	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 8mA$		0.20	0.40		0.50	V
I <sub>I</sub>	Input leakage current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}$			1.0		1.0	μΑ
I <sub>OZ</sub>	3-State output OFF-state current				5		10	μΑ
I <sub>CC</sub>	Quiescent supply current; MSI	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		160	μA
$\Delta I_{CC}$	Additional quiescent supply current per input	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μA

NOTE:

1 All typical values are measured at  $T_{amb} = 25^{\circ}C$ .

74LV368

Product specification

## 74LV368

#### **AC CHARACTERISTICS**

GND = 0V;  $t_r = t_f = 2.5ns$ ;  $C_L = 50pF$ ;  $R_L = 1K\Omega$ 

SYMBOL	PARAMETER	WAVEFORM	CONDITION		LIMITS 40 to +85 °	С	LIM -40 to -	<b>ITS</b> ⊧125 °C	UNIT		
			V <sub>CC</sub> (V)	MIN	TYP <sup>1</sup>	MAX	MIN	MAX			
			1.2	-	55	-	-	-			
too tour	Propagation delay	Figures, 1, 3	2.0	-	19	36	-	44	ns		
t <sub>PZL</sub> /t <sub>PLH</sub>	nA, to nY	rigures, i, 5	2.7	-	14	26	-	33	115		
			3.0 to 3.6	-	10 <sup>2</sup>	21	-	26			
					1.2	-	75	-	-	-	
tanutan	3-State output enable time	Figures, 2, 3	2.0	-	26	49	-	60	ns		
t <sub>PZH</sub> /t <sub>PZL</sub>	$n\overline{OE}$ to $n\overline{Y}$			Figures, 2, 3	2.7	-	19	36	-	44	113
			3.0 to 3.6	-	14 <sup>2</sup>	29	-	35			
			1.2	-	90	-	-	-			
tourtour	3-State output tpuz/tpuz disable time	Figures, 2, 3	2.0	-	32	59	-	70	ns		
t <sub>PHZ</sub> /t <sub>PLZ</sub>	$n\overline{OE}$ to $n\overline{Y}$		2.7	-	24	44	-	52	115		
			3.0 to 3.6	-	19 <sup>2</sup>	36	-	42			

#### NOTE:

1 Unless otherwise stated, all typical values are at  $T_{amb} = 25^{\circ}C$ .

2 Typical value measured at  $V_{CC} = 3.3V$ .

#### AC WAVEFORMS

$$\begin{split} & \mathsf{V}_{\mathsf{M}} = 1.5\mathsf{V} \text{ at } \mathsf{V}_{\mathsf{CC}} \geq 2.7\mathsf{V} \\ & \mathsf{V}_{\mathsf{M}} = 0.5\mathsf{V}^* \, \mathsf{V}_{\mathsf{CC}} \text{ at } \mathsf{V}_{\mathsf{CC}} < 2.7\mathsf{V} \\ & \mathsf{V}_{\mathsf{OL}} \text{ and } \mathsf{V}_{\mathsf{OH}} \text{ are the typical output voltage drop that occur with the output load.} \\ & \mathsf{V}_{\mathsf{X}} = \mathsf{V}_{\mathsf{OL}} + 0.3\mathsf{V} \text{ at } \mathsf{V}_{\mathsf{CC}} \geq 2.7\mathsf{V} \\ & \mathsf{V}_{\mathsf{X}} = \mathsf{V}_{\mathsf{OL}} + 0.1^* \, \mathsf{V}_{\mathsf{CC}} \text{ at } \mathsf{V}_{\mathsf{CC}} < 2.7\mathsf{V} \\ & \mathsf{V}_{\mathsf{Y}} = \mathsf{V}_{\mathsf{OH}} - 0.3\mathsf{V} \text{ at } \mathsf{V}_{\mathsf{CC}} \geq 2.7\mathsf{V} \\ & \mathsf{V}_{\mathsf{Y}} = \mathsf{V}_{\mathsf{OH}} - 0.3\mathsf{V} \text{ at } \mathsf{V}_{\mathsf{CC}} \geq 2.7\mathsf{V} \\ & \mathsf{V}_{\mathsf{Y}} = \mathsf{V}_{\mathsf{OH}} - 0.1\mathsf{V}_{\mathsf{CC}} \text{ at } \mathsf{V}_{\mathsf{CC}} < 2.7\mathsf{V} \end{split}$$

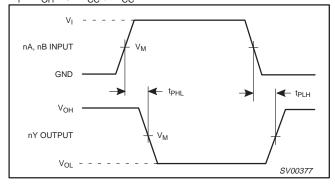


Figure 1.Input (nA) to output  $(n\overline{Y})$  propagation delay

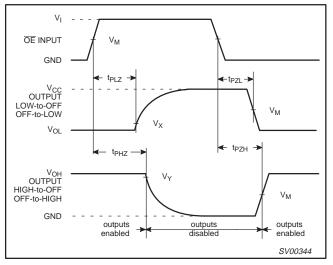


Figure 2. 3-State enable and disable times

#### Product specification

## 74LV368

#### **TEST CIRCUIT**

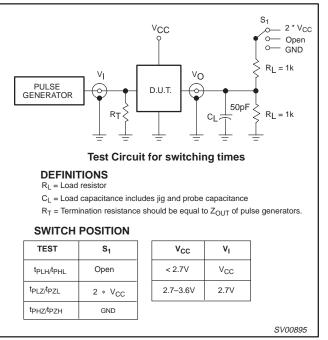
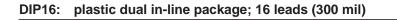
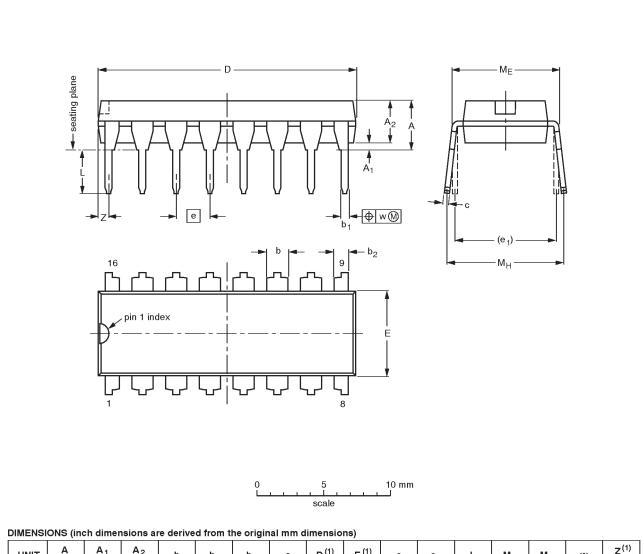


Figure 3. Load circuitry for switching times





UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

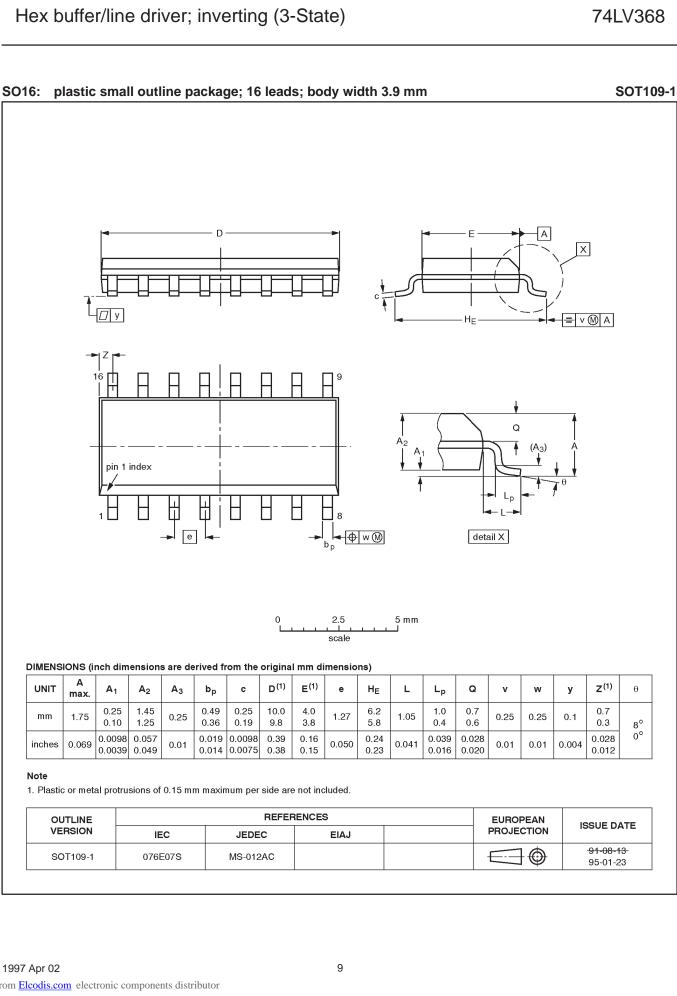
#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEDEC EIAJ		PROJECTION	ISSUE DATE	
SOT38-4						<del>-92-11-17-</del> 95-01-14	

SOT38-4

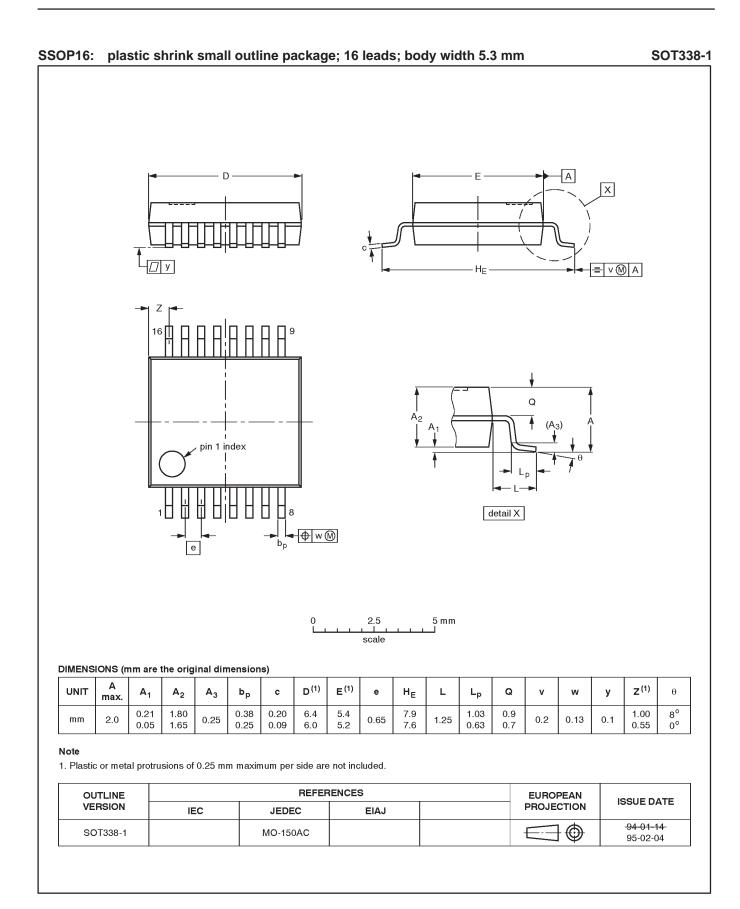
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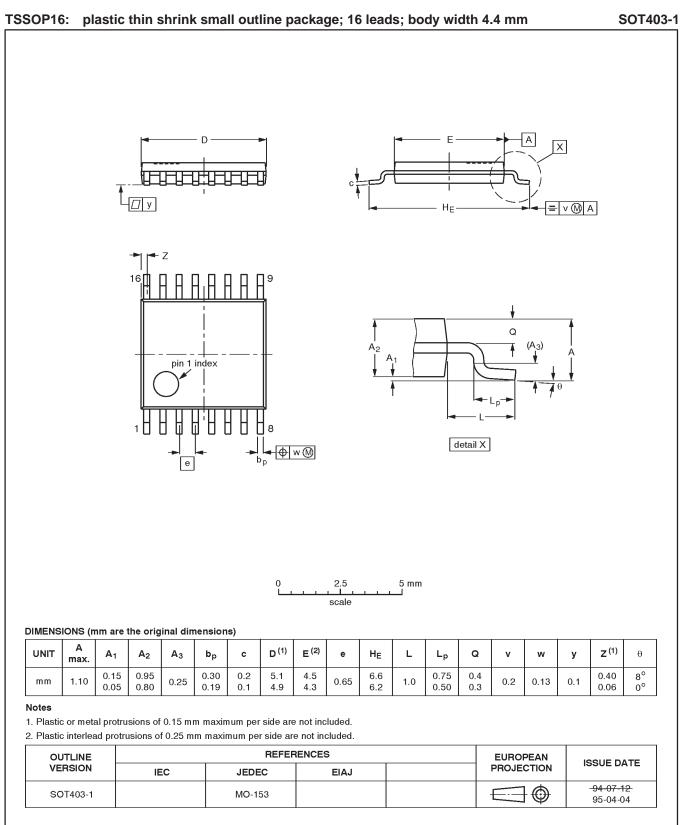
#### Product specification

## Hex buffer/line driver; inverting (3-State)

## 74LV368



74LV368



## 74LV368

DEFINITIONS							
Data Sheet Identification	Product Status	Definition					
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.					
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